

RM 5, RM 5 LP Core and accessories

Series/Type: B65805, B65806, B65822, B65539, B65518

Date: May 2017

The following products presented in this data sheet are being withdrawn.

Ordering Code	Substitute Product		Deadline Last Orders	Last Shipments
B65806A5000X000		2018-06-08	2018-09-14	2018-12-14

For further information please contact your nearest EPCOS sales office, which will also support you in selecting a suitable substitute. The addresses of our worldwide sales network are presented at www.epcos.com/sales.

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### Core and accessories

	Individual parts	Part no.	Page
	Adjusting screw	B65518 B65539 B65806	9
	Core	B65805	3
	Clamps	B65806	6
	Insulating washer 1	B65806	6
	Coil former	B65806	5
	Core	B65805	3
	Threaded sleeve (glued-in)		
	Insulating washer 2	B65806	6
FRM0005-2			
Example of an assembly set			
Also available:	SMD coil formers Clamps	B65822 B65806	7, 8 7, 8
	RM 5 low profile: Core	B65805P	10



### Core B65805

■ To IEC 62317-4

Core without center hole for transformer applications

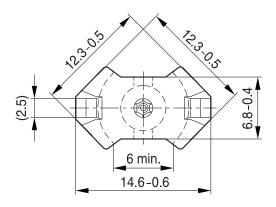
■ Delivery mode: sets

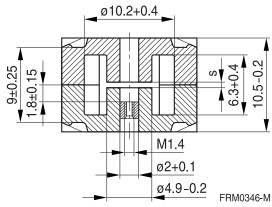
### Magnetic characteristics (per set)

	with center hole	without center hole	
ΣΙ/Α	1.0	0.93	mm <sup>-1</sup>
l <sub>e</sub>	20.8	22.1	mm
I <sub>e</sub> A <sub>e</sub>	20.8	23.8	mm <sup>2</sup>
$A_{min}$		18	mm <sup>2</sup>
V <sub>e</sub>	433	526	mm <sup>3</sup>

### Approx. weight (per set)

m	2.9	3.0	g





### **Gapped** (A<sub>L</sub> values/air gaps examples)

Material	A <sub>L</sub> value	s approx. mm	$\mu_{e}$	Ordering code <sup>1)</sup> -C with center hole -N with threaded sleeve
K1	25 ±3%	1.0	19.9	B65805+0025A001
	40 ±3%	0.40	31.8	B65805+0040A001
M33	63 ±3%	0.4	50.2	B65805+0063A033
	100 ±3%	0.2	79.6	B65805+0100A033
N48	160 ±3%	0.12	127	B65805+0160A048
	250 ±3%	0.06	199	B65805+0250A048
	315 ±3%	0.03	251	B65805+0315A048

<sup>1)</sup> Replace the + by the code letter "C" or "N" for the required version.



RM 5	
Core	B65805

### **Ungapped**

Material	A <sub>L</sub> value	$\mu_{e}$	P <sub>V</sub>	Ordering code -C with center hole
	nH		W/set	-J without center hole
N48	1800 +30/–20%	1430		B65805C0000R048
N45	2600 +30/–20%	1920		B65805J0000R045
N30	3500 +30/–20%	2590		B65805J0000R030
T38	6700 +40/–30%	4950		B65805J0000Y038
T66	9600 +40/–30%	7090		B65805J0000Y066
N49	1300 +30/–20%	960	< 0.06 ( 50 mT, 500 kHz, 100 °C)	B65805J0000R049
N87	2000 +30/–20%	1480	< 0.32 (200 mT, 100 kHz, 100 °C)	B65805J0000R087
N97	2000 +30/–20%	1480	< 0.24 (200 mT, 100 kHz, 100 °C)	B65805J0000R097
N41	2600 +30/–20%	1920	< 0.10 (200 mT, 25 kHz, 100 °C)	B65805J0000R041

Other  $A_L$  values/air gaps and materials available on request — see Processing remarks on page 11.



### Accessories B65806

#### **Coil former**

Material: GFR thermosetting plastic (UL 94 V-0, insulation class to IEC 60085:

 $\mathsf{F} \cong \mathsf{max}$ . operating temperature 155 °C), color code black

SUMIKON PM 9630 [E41429 (M)], SUMITOMO BAKELITE CO LTD

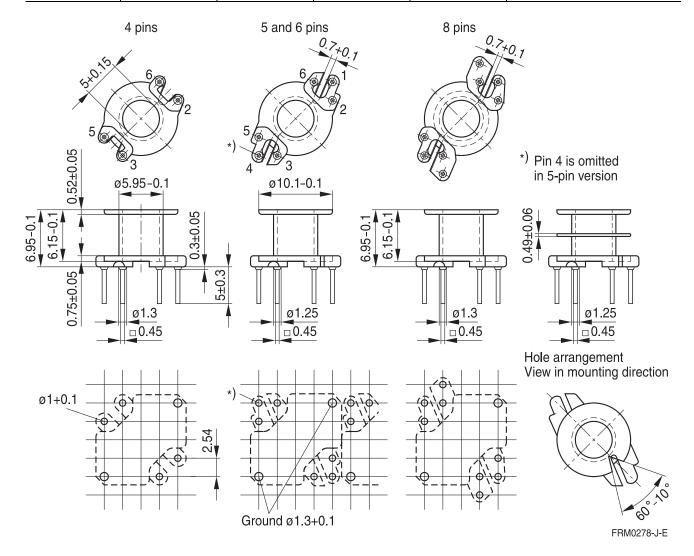
Solderability: to IEC 60068-2-20, test Ta, method 1 (aging 3): 235 °C, 2 s

Resistance to soldering heat: to IEC 60068-2-20, test Tb, method 1B: 350 °C, 3.5 s

Winding: see Processing notes, 2.1

For matching clamps and insulating washers see page 6.

Sections	A <sub>N</sub> mm <sup>2</sup>	I <sub>N</sub> mm	$A_R$ value $\mu\Omega$	Pins	Ordering code
1	9.5	25	90	4 5 6 8	B65806N1104D001 B65806N1105D001 B65806N1106D001 B65806N1108D001
2	8.7	25	94	6	B65806N1106D002





Accessories B65806

### Clamp

- With ground terminal, made of stainless spring steel (tinned), 0.3 mm thick
- Solderability to IEC 60068-2-20, test Ta, method 1 (aging 3): 235 °C, 2 s

#### Insulating washer 1 between core and coil former

- For tolerance compensation and for insulation
- Made of polyarylate film (UL 94 V-0, insulation class to IEC 60085: E 120 °C), 0.08 mm thick Aryphan F685, [E167358 (M)], natural color, LOFO HIGH TECH FILM GMBH

#### Insulating washer 2 for double-clad PCBs

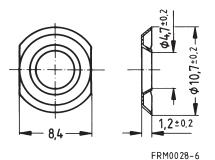
■ Made of polycarbonate (UL 94 V-0, insulation class to IEC 60085: E 120 °C), 0.25 mm thick Makrofol FR7-2 [E168120 (M)], COVESTRO AG

	Ordering code
Clamp (ordering code per piece, 2 are required)	B65806B2203X000
Insulating washer 1 (reel packing, PU = 1 reel)	B65806A5000X000
Insulating washer 2 (bulk)	B65806D2005X000

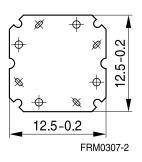
#### Clamp

# 0.55-0.15 8.3+0.2 0.55-0.15 8.3+0.15 0.4.5-0.3 6.3-0.15 6.3-0.15 7.0-0.15

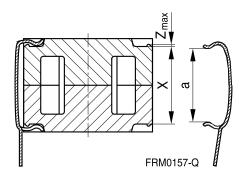
### Insulating washer 1



Insulating washer 2



### Clamping forces for RM 5



 $F_{min}$ : Extension of clamp from a to  $a_2 = X_{min}$  $F_{max}$ : Extension of clamp from a to  $a_1 = X_{max}$ 

Clamp opening a (mm)	8.3 +0.15	
Core nose Z <sub>max</sub> (mm)	0.15	
Height of core pair X (mm	n)X <sub>min</sub> X <sub>max</sub>	8.75 9.25
Clamping force F (N)	F <sub>min</sub> F <sub>max</sub>	5 40



### Accessories B65822, B65806



### SMD coil former with gullwing terminals

Material: GFR liquid crystal polymer (UL 94 V-0, insulation class to IEC 60085:

 $\mathsf{F} \cong \mathsf{max}$ . operating temperature 155 °C), color code black

Vectra C 130 [E83005 (M)], CELANESE INTERNATIONAL CORP.

Solderability: to IEC 60068-2-58, test Td, method 6 (Group 3): 245 °C, 3 s

Resistance to soldering heat: to IEC 60068-2-58, test Td, method 6 (Group 3): 255 °C, 10 s

permissible soldering temperature for wire-wrap connection on coil former: 400 °C, 1 s

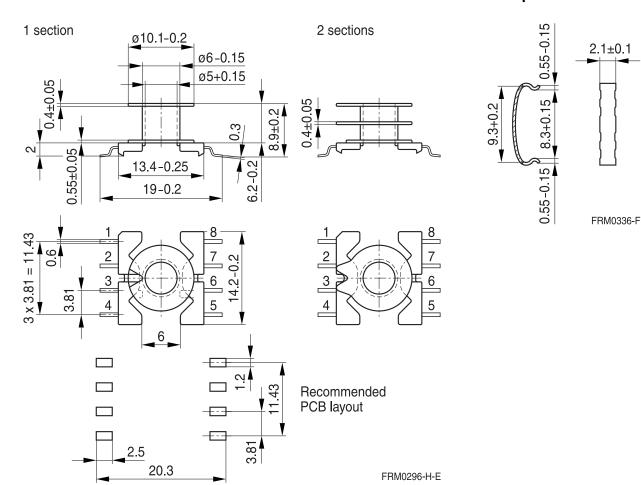
Winding: see Processing notes, 2.1

#### Clamp

■ Without ground terminal, made of stainless spring steel, 0.335 mm thick

Sections	A <sub>N</sub> mm <sup>2</sup>	I <sub>N</sub> mm	$A_R$ value $\mu\Omega$	Terminals	Ordering code
1	11.1	25	77	8	B65822F1008T001
2	10.2	25	85	8	B65822F1008T002
Clamp(ordering code per piece, 2 are required)					B65806J2204X000

### Coil former Clamp





### Accessories B65822, B65806



#### SMD coil former with J terminals

Material: GFR liquid crystal polymer (UL 94 V-0, insulation class to IEC 60085:

F 

max. operating temperature 155 °C), color code black

Vectra C 130 [E83005 (M)], CELANESE INTERNATIONAL CORP.

Solderability: to IEC 60068-2-58, test Td, method 6 (Group 3): 245 °C, 3 s

Resistance to soldering heat: to IEC 60068-2-58, test Td, method 6 (Group 3): 255 °C, 10 s

permissible soldering temperature for wire-wrap connection on coil former: 400 °C, 1 s

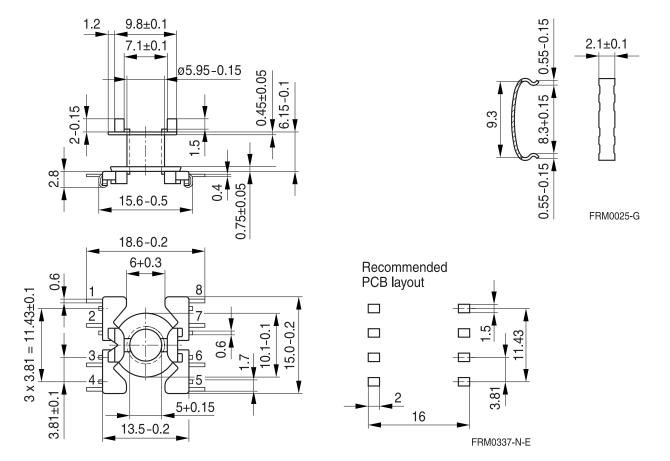
Winding: see Processing notes, 2.1

#### Clamp

■ Without ground terminal, made of stainless spring steel, 0.335 mm thick

Sections	A <sub>N</sub> mm <sup>2</sup>	I <sub>N</sub> mm	$A_R$ value $\mu\Omega$	Terminals	Ordering code
1	11.1	25	73	8	B65822J1008T001
Clamp(ordering code per piece, 2 are required)					B65806J2204X000

### Coil former Clamp





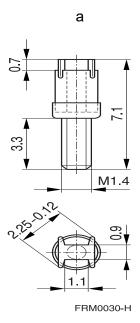
### **Accessories**

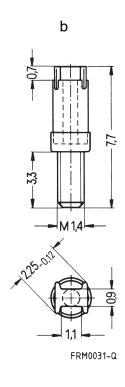
B65539, B65806, B65518

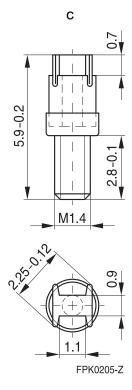
### **Adjusting screw**

■ Tube core with thread and core brake made of GFR polyterephthalate Pocan B3235® [E245249 (M)], LANXESS AG

Figure	gure Tube core			Ordering code	
	$\emptyset \times \text{length (mm)}$	Material	Color code	-	
а	1.81 × 2.0	K1	yellow	B65539C1003X001	
а	1.81 × 2.7	N22	red	B65539C1002X022	
b	1.81 × 3.4	N22	green	B65806C3001X022	
С	1.81 × 2.0	K1	blue	B65518C3000X001	









### RM 5 »Low Profile«

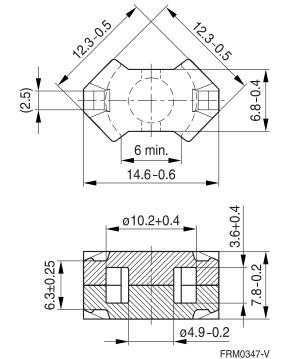
### Core B65805P

- To IEC 62317-4
- For compact transformers
- Without center hole
- Delivery mode: sets

### Magnetic characteristics (per set)

 $\Sigma$ I/A = 0.71 mm<sup>-1</sup>  $I_e$  = 17.5 mm  $A_e$  = 24.5 mm<sup>2</sup>  $A_{min}$  = 18 mm<sup>2</sup>  $V_e$  = 430 mm<sup>3</sup>

Approx. weight 2.6 g/set



### **Ungapped**

Material	A <sub>L</sub> value	$\mu_{e}$	P <sub>V</sub>	Ordering code
	nH		W/set	
T38	7700 +40/–30%	4380		B65805P0000Y038
N49	1700 +30/–20%	970	< 0.09 ( 50 mT, 500 kHz, 100 °C)	B65805P0000R049
N92	1900 +30/–20%	1080	< 0.29 (200 mT, 100 kHz, 100 °C)	B65805P0000R092
N87	2400 +30/–20%	1360	< 0.26 (200 mT, 100 kHz, 100 °C)	B65805P0000R087

Other A<sub>I</sub> values/air gaps and materials available on request — see Processing remarks on page 11.



### **Cautions and warnings**

#### Mechanical stress and mounting

Ferrite cores have to meet mechanical requirements during assembling and for a growing number of applications. Since ferrites are ceramic materials one has to be aware of the special behavior under mechanical load.

As valid for any ceramic material, ferrite cores are brittle and sensitive to any shock, fast temperature changing or tensile load. Especially high cooling rates under ultrasonic cleaning and high static or cyclic loads can cause cracks or failure of the ferrite cores.

For detailed information see data book, chapter "General - Definitions, 8.1".

#### Effects of core combination on A<sub>I</sub> value

Stresses in the core affect not only the mechanical but also the magnetic properties. It is apparent that the initial permeability is dependent on the stress state of the core. The higher the stresses are in the core, the lower is the value for the initial permeability. Thus the embedding medium should have the greatest possible elasticity.

For detailed information see data book, chapter "General - Definitions, 8.1".

#### Heating up

Ferrites can run hot during operation at higher flux densities and higher frequencies.

#### NiZn-materials

The magnetic properties of NiZn-materials can change irreversible in high magnetic fields.

#### **Ferrite Accessories**

EPCOS ferrite accessories have been designed and evaluated only in combination with EPCOS ferrite cores. EPCOS explicitly points out that EPCOS ferrite accessories or EPCOS ferrite cores may not be compatible with those of other manufacturers. Any such combination requires prior testing by the customer and will be at the customer's own risk.

EPCOS assumes no warranty or reliability for the combination of EPCOS ferrite accessories with cores and other accessories from any other manufacturer.

#### **Processing remarks**

The start of the winding process should be soft. Else the flanges may be destroyed.

- Too strong winding forces may blast the flanges or squeeze the tube that the cores can not be mounted any more.
- Too long soldering time at high temperature (>300 °C) may effect coplanarity or pin arrangement.
- Not following the processing notes for soldering of the J-leg terminals may cause solderability
  problems at the transformer because of pollution with Sn oxyde of the tin bath or burned insulation of the wire. For detailed information see chapter "Processing notes", section 2.2.
- The dimensions of the hole arrangement have fixed values and should be understood as a recommendation for drilling the printed circuit board. For dimensioning the pins, the group of holes can only be seen under certain conditions, as they fit into the given hole arrangement. To avoid problems when mounting the transformer, the manufacturing tolerances for positioning the customers' drilling process must be considered by increasing the hole diameter.

11



### **Cautions and warnings**

### Display of ordering codes for EPCOS products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications and the website of EPCOS, or in order-related documents such as shipping notes, order confirmations and product labels. The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products. Detailed information can be found on the Internet under www.epcos.com/orderingcodes.



# Symbols and terms

Symbol	Meaning	Unit
A	Cross section of coil	mm <sup>2</sup>
$A_{e}$	Effective magnetic cross section	mm <sup>2</sup>
$A_{L}$	Inductance factor; $A_L = L/N^2$	nH
$A_{L1}$	Minimum inductance at defined high saturation ( $\stackrel{\triangle}{=} \mu_a$ )	nH
A <sub>min</sub>	Minimum core cross section	mm <sup>2</sup>
$A_N$	Winding cross section	mm <sup>2</sup>
$A_R$	Resistance factor; $A_R = R_{Cu}/N^2$	$\mu\Omega = 10^{-6} \Omega$
В	RMS value of magnetic flux density	Vs/m <sup>2</sup> , mT
$\Delta B$	Flux density deviation	Vs/m <sup>2</sup> , mT
Ê	Peak value of magnetic flux density	Vs/m <sup>2</sup> , mT
ΔÂ	Peak value of flux density deviation	Vs/m <sup>2</sup> , mT
$B_DC$	DC magnetic flux density	Vs/m <sup>2</sup> , mT
$B_R$	Remanent flux density	Vs/m <sup>2</sup> , mT
$B_S$	Saturation magnetization	Vs/m <sup>2</sup> , mT
$C_0$	Winding capacitance	F = As/V
CDF	Core distortion factor	mm <sup>-4.5</sup>
DF	Relative disaccommodation coefficient DF = $d/\mu_i$	
d	Disaccommodation coefficient	
$E_a$	Activation energy	J
f	Frequency	s <sup>−1</sup> , Hz
f <sub>cutoff</sub>	Cut-off frequency	s−1, Hz
f <sub>max</sub>	Upper frequency limit	s <sup>−1</sup> , Hz
f <sub>min</sub>	Lower frequency limit	s−1, Hz
f <sub>r</sub>	Resonance frequency	s <sup>−1</sup> , Hz
$f_{Cu}$	Copper filling factor	
g	Air gap	mm
Н	RMS value of magnetic field strength	A/m
Ĥ	Peak value of magnetic field strength	A/m
$H_{DC}$	DC field strength	A/m
H <sub>c</sub>	Coercive field strength	A/m
h	Hysteresis coefficient of material	10 <sup>-6</sup> cm/A
$h/\mu_i^2$	Relative hysteresis coefficient	10 <sup>-6</sup> cm/A
1	RMS value of current	Α
$I_{DC}$	Direct current	Α
î	Peak value of current	Α
J	Polarization	Vs/m <sup>2</sup>
k	Boltzmann constant	J/K
$k_3$	Third harmonic distortion	
k <sub>3c</sub>	Circuit third harmonic distortion	
L	Inductance	H = Vs/A



# Symbols and terms

Symbol	Meaning	Unit
$\Delta$ L/L	Relative inductance change	Н
$L_0$	Inductance of coil without core	Н
$L_H$	Main inductance	Н
$L_p$	Parallel inductance	Н
L <sub>rev</sub>	Reversible inductance	Н
L <sub>s</sub>	Series inductance	Н
l <sub>e</sub>	Effective magnetic path length	mm
$I_N$	Average length of turn	mm
N	Number of turns	
$P_{Cu}$	Copper (winding) losses	W
P <sub>trans</sub>	Transferrable power	W
$P_V$	Relative core losses	mW/g
PF	Performance factor	
Q	Quality factor (Q = $\omega L/R_s$ = 1/tan $\delta_l$ )	
R	Resistance	Ω
$R_{Cu}$	Copper (winding) resistance (f = 0)	Ω
R <sub>h</sub>	Hysteresis loss resistance of a core	Ω
$\Delta R_h$	R <sub>h</sub> change	Ω
R <sub>i</sub>	Internal resistance	Ω
$R_p$	Parallel loss resistance of a core	Ω
$R_s$	Series loss resistance of a core	Ω
R <sub>th</sub>	Thermal resistance	K/W
$R_V$	Effective loss resistance of a core	Ω
S	Total air gap	mm
Т	Temperature	°C
$\DeltaT$	Temperature difference	K
$T_{C}$	Curie temperature	°C
t	Time	s
$t_v$	Pulse duty factor	
tan δ	Loss factor	
tan $\delta_l$	Loss factor of coil	
tan $\delta_r$	(Residual) loss factor at H $\rightarrow$ 0	
tan $\delta_{\rm e}$	Relative loss factor	
tan $\delta_h$	Hysteresis loss factor	
tan δ/μ <sub>i</sub>	Relative loss factor of material at H $\rightarrow$ 0	
U	RMS value of voltage	V
Û	Peak value of voltage	V
V <sub>e</sub>	Effective magnetic volume	mm <sup>3</sup>
Z	Complex impedance	$\Omega$
Z <sub>n</sub>	Normalized impedance $ Z _n =  Z  / N^2 \times \varepsilon ( I_e /A_e)$	Ω/mm



# Symbols and terms

Symbol	Meaning	Unit
α	Temperature coefficient (TK)	1/K
$\alpha_{F}$	Relative temperature coefficient of material	1/K
$\alpha_{e}$	Temperature coefficient of effective permeability	1/K
$\epsilon_{r}$	Relative permittivity	
Φ	Magnetic flux	Vs
η	Efficiency of a transformer	
η <sub>B</sub>	Hysteresis material constant	
η <sub>i</sub>	Hysteresis core constant	$A^{-1}H^{-1/2}$
$\lambda_{\sf s}$	Magnetostriction at saturation magnetization	
ı	Relative complex permeability	
$\iota_0$	Magnetic field constant	Vs/Am
la	Relative amplitude permeability	
<sup>l</sup> app	Relative apparent permeability	
le	Relative effective permeability	
ιį	Relative initial permeability	
ι <sub>p</sub> '	Relative real (inductive) component of $\overline{\mu}$ (for parallel components)	
ι <sub>p</sub> "	Relative imaginary (loss) component of $\overline{\mu}$ (for parallel components)	
$\iota_{r}$	Relative permeability	
$\iota_{rev}$	Relative reversible permeability	
ι <sub>s</sub> '	Relative real (inductive) component of $\overline{\mu}$ (for series components)	
ι <sub>s</sub> "	Relative imaginary (loss) component of $\overline{\mu}$ (for series components)	
$\iota_{tot}$	Relative total permeability	
	derived from the static magnetization curve	
)	Resistivity	$\Omega$ m $^{-1}$
ΣΙ/A	Magnetic form factor	mm <sup>-1</sup>
<sup>r</sup> Cu	DC time constant $\tau_{Cu} = L/R_{Cu} = A_L/A_R$	s
ω	Angular frequency; $\omega$ = 2 $\Pi$ f	s <sup>-1</sup>

All dimensions are given in mm.





#### Important notes

The following applies to all products named in this publication:

- 1. Some parts of this publication contain statements about the suitability of our products for certain areas of application. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application. As a rule we are either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether a product with the properties described in the product specification is suitable for use in a particular customer application.
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Release 2018-10

# **Mouser Electronics**

**Authorized Distributor** 

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B65806B2203X B65805C0000R041 B65806A5000X000 B65806C3001X22 B65822F1008T1 B65822J1008T1

B65822F1008T2 B65806D2005X B65806A5000X B65518C3000X1 B65805C100A33 B65805C63A33 B65805PY38

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- Поставка оригинальных импортных электронных компонентов напрямую с производств Америки, Европы и Азии, а так же с крупнейших складов мира;
- Широкая линейка поставок активных и пассивных импортных электронных компонентов (более 30 млн. наименований);
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Помощь Конструкторского Отдела и консультации квалифицированных инженеров;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Поставка электронных компонентов под контролем ВП;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- При необходимости вся продукция военного и аэрокосмического назначения проходит испытания и сертификацию в лаборатории (по согласованию с заказчиком);
- Поставка специализированных компонентов военного и аэрокосмического уровня качества (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Actel, Aeroflex, Peregrine, VPT, Syfer, Eurofarad, Texas Instruments, MS Kennedy, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Компания «Океан Электроники» является официальным дистрибьютором и эксклюзивным представителем в России одного из крупнейших производителей разъемов военного и аэрокосмического назначения «JONHON», а так же официальным дистрибьютором и эксклюзивным представителем в России производителя высокотехнологичных и надежных решений для передачи СВЧ сигналов «FORSTAR».



**«JONHON»** (основан в 1970 г.)

Разъемы специального, военного и аэрокосмического назначения:

(Применяются в военной, авиационной, аэрокосмической, морской, железнодорожной, горно- и нефтедобывающей отраслях промышленности)

«**FORSTAR**» (основан в 1998 г.)

ВЧ соединители, коаксиальные кабели, кабельные сборки и микроволновые компоненты:

(Применяются в телекоммуникациях гражданского и специального назначения, в средствах связи, РЛС, а так же военной, авиационной и аэрокосмической отраслях промышленности).



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